

TAPE AND REEL INFORMATION



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TLE2141AIDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLE2141CDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLE2141IDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLE2141MDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLE2142ACDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLE2142AIDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLE2142AMDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLE2142CDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLE2142CPWR	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
TLE2142IDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLE2142MDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLE2144CDWR	SOIC	DW	16	2000	330.0	16.4	10.75	10.7	2.7	12.0	16.0	Q1
TLE2144IDWR	SOIC	DW	16	2000	330.0	16.4	10.75	10.7	2.7	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TLE2141AIDR	SOIC	D	8	2500	353.0	353.0	32.0
TLE2141CDR	SOIC	D	8	2500	340.5	338.1	20.6
TLE2141IDR	SOIC	D	8	2500	353.0	353.0	32.0
TLE2141MDR	SOIC	D	8	2500	350.0	350.0	43.0
TLE2142ACDR	SOIC	D	8	2500	353.0	353.0	32.0
TLE2142AIDR	SOIC	D	8	2500	353.0	353.0	32.0
TLE2142AMDR	SOIC	D	8	2500	350.0	350.0	43.0
TLE2142CDR	SOIC	D	8	2500	353.0	353.0	32.0
TLE2142CPWR	TSSOP	PW	16	2000	353.0	353.0	32.0
TLE2142IDR	SOIC	D	8	2500	353.0	353.0	32.0
TLE2142MDR	SOIC	D	8	2500	350.0	350.0	43.0
TLE2144CDWR	SOIC	DW	16	2000	350.0	350.0	43.0
TLE2144IDWR	SOIC	DW	16	2000	350.0	350.0	43.0

TUBE


*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
5962-9321603Q2A	FK	LCCC	20	55	506.98	12.06	2030	NA
5962-9321603QHA	U	CFP	10	25	506.98	26.16	6220	NA
5962-9321604Q2A	FK	LCCC	20	55	506.98	12.06	2030	NA
5962-9321604QHA	U	CFP	10	25	506.98	26.16	6220	NA
5962-9321605Q2A	FK	LCCC	20	55	506.98	12.06	2030	NA
5962-9321606Q2A	FK	LCCC	20	55	506.98	12.06	2030	NA
TLE2141ACP	P	PDIP	8	50	506	13.97	11230	4.32
TLE2141ACP.A	P	PDIP	8	50	506	13.97	11230	4.32
TLE2141AIP	P	PDIP	8	50	506	13.97	11230	4.32
TLE2141AIP.A	P	PDIP	8	50	506	13.97	11230	4.32
TLE2141CP	P	PDIP	8	50	506	13.97	11230	4.32
TLE2141CP.A	P	PDIP	8	50	506	13.97	11230	4.32
TLE2141IP	P	PDIP	8	50	506	13.97	11230	4.32
TLE2141IP.A	P	PDIP	8	50	506	13.97	11230	4.32
TLE2141MD	D	SOIC	8	75	505.46	6.76	3810	4
TLE2141MD.A	D	SOIC	8	75	505.46	6.76	3810	4
TLE2142AMFKB	FK	LCCC	20	55	506.98	12.06	2030	NA
TLE2142AMFKB.A	FK	LCCC	20	55	506.98	12.06	2030	NA
TLE2142AMUB	U	CFP	10	25	506.98	26.16	6220	NA
TLE2142AMUB.A	U	CFP	10	25	506.98	26.16	6220	NA
TLE2142CP	P	PDIP	8	50	506	13.97	11230	4.32
TLE2142CP.A	P	PDIP	8	50	506	13.97	11230	4.32
TLE2142IP	P	PDIP	8	50	506	13.97	11230	4.32
TLE2142IP.A	P	PDIP	8	50	506	13.97	11230	4.32
TLE2142MFKB	FK	LCCC	20	55	506.98	12.06	2030	NA
TLE2142MFKB.A	FK	LCCC	20	55	506.98	12.06	2030	NA
TLE2142MUB	U	CFP	10	25	506.98	26.16	6220	NA
TLE2142MUB.A	U	CFP	10	25	506.98	26.16	6220	NA
TLE2144ACN	N	PDIP	14	25	506	13.97	11230	4.32

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
TLE2144ACN.A	N	PDIP	14	25	506	13.97	11230	4.32
TLE2144AIN	N	PDIP	14	25	506	13.97	11230	4.32
TLE2144AIN.A	N	PDIP	14	25	506	13.97	11230	4.32
TLE2144AMFKB	FK	LCCC	20	55	506.98	12.06	2030	NA
TLE2144AMFKB.A	FK	LCCC	20	55	506.98	12.06	2030	NA
TLE2144CDW	DW	SOIC	16	40	506.98	12.7	4826	6.6
TLE2144CDW.A	DW	SOIC	16	40	506.98	12.7	4826	6.6
TLE2144CN	N	PDIP	14	25	506	13.97	11230	4.32
TLE2144CN.A	N	PDIP	14	25	506	13.97	11230	4.32
TLE2144IDW	DW	SOIC	16	40	506.98	12.7	4826	6.6
TLE2144IDW.A	DW	SOIC	16	40	506.98	12.7	4826	6.6
TLE2144IN	N	PDIP	14	25	506	13.97	11230	4.32
TLE2144IN.A	N	PDIP	14	25	506	13.97	11230	4.32
TLE2144MDW	DW	SOIC	16	40	506.98	12.7	4826	6.6
TLE2144MDW.A	DW	SOIC	16	40	506.98	12.7	4826	6.6
TLE2144MDWG4	DW	SOIC	16	40	506.98	12.7	4826	6.6
TLE2144MDWG4.A	DW	SOIC	16	40	506.98	12.7	4826	6.6
TLE2144MFKB	FK	LCCC	20	55	506.98	12.06	2030	NA
TLE2144MFKB.A	FK	LCCC	20	55	506.98	12.06	2030	NA